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(12) **United States Design Patent**
Wu

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(54) **EARPHONES**

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(**) Term: **15 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (12) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223; D14/205**

(58) **Field of Classification Search**
USPC D14/223, 205; D9/721, 496; 181/129, 181/130, 135; 379/430, 431; 381/380, 381/381, 379, 370; 455/90.3, 575.1, 455/569.1

CPC H04R 1/10; H04R 25/00; H04R 1/1066; H04R 5/033; H04R 5/0335; H04R 1/1058; H04R 1/105; H04R 1/1091

See application file for complete search history.

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Primary Examiner — Paula Allen Greene

(57) **CLAIM**

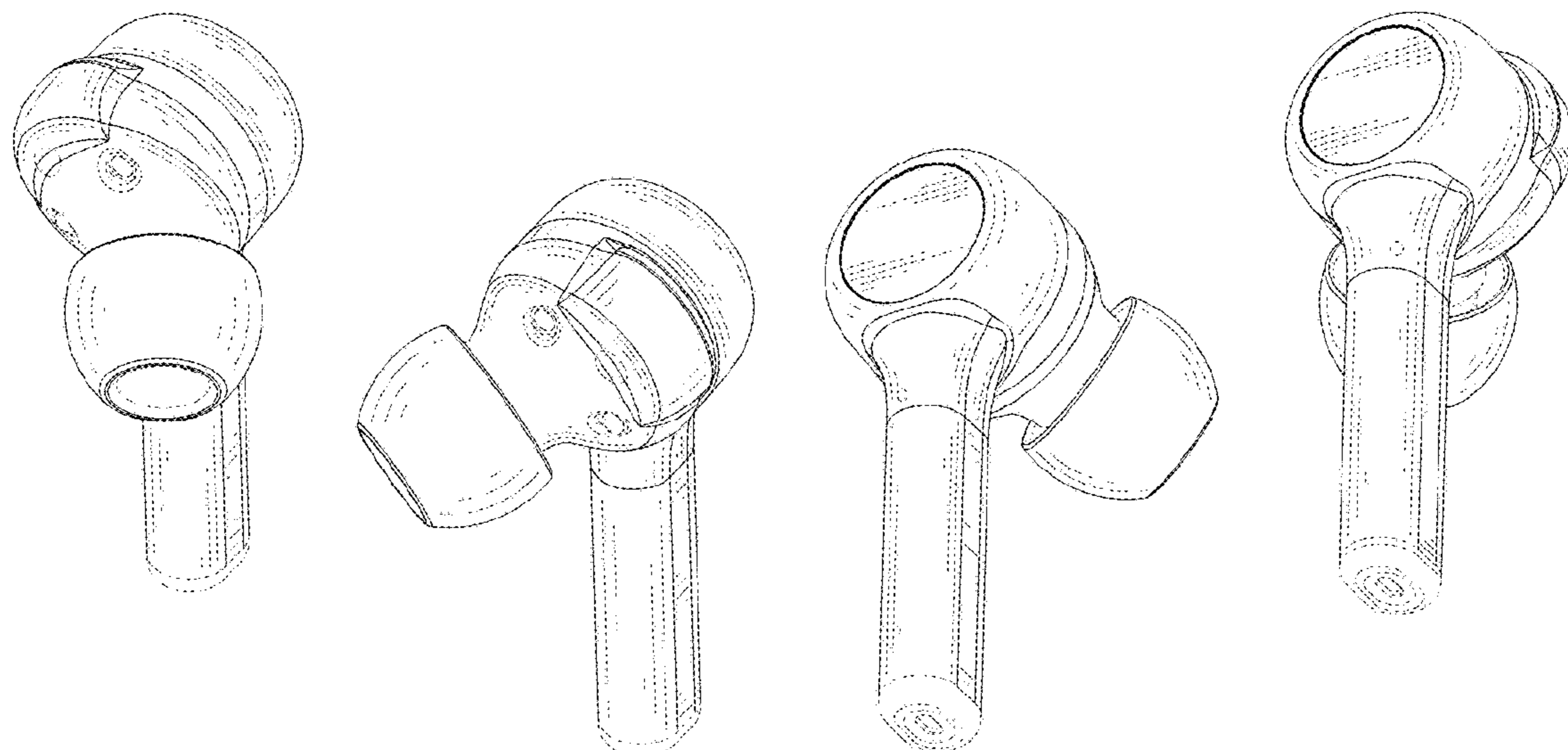
The ornamental design for earphones, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of earphones showing my new design;
 FIG. 2 is another perspective view thereof;
 FIG. 3 is a front elevational view thereof;
 FIG. 4 is a rear elevational view thereof;
 FIG. 5 is a left side elevational view thereof;
 FIG. 6 is a right side elevational view thereof;
 FIG. 7 is a top plan view thereof;
 FIG. 8 is a bottom plan view thereof; and,
 FIG. 9 is a perspective view of the earphones where the earphones are received in a case.

The broken lines immediately adjacent the shaded areas represent the bounds of the claimed design while all other broken lines are directed to environment and are for illustrative purposes only. The broken lines from no part of the claimed design.

1 Claim, 9 Drawing Sheets



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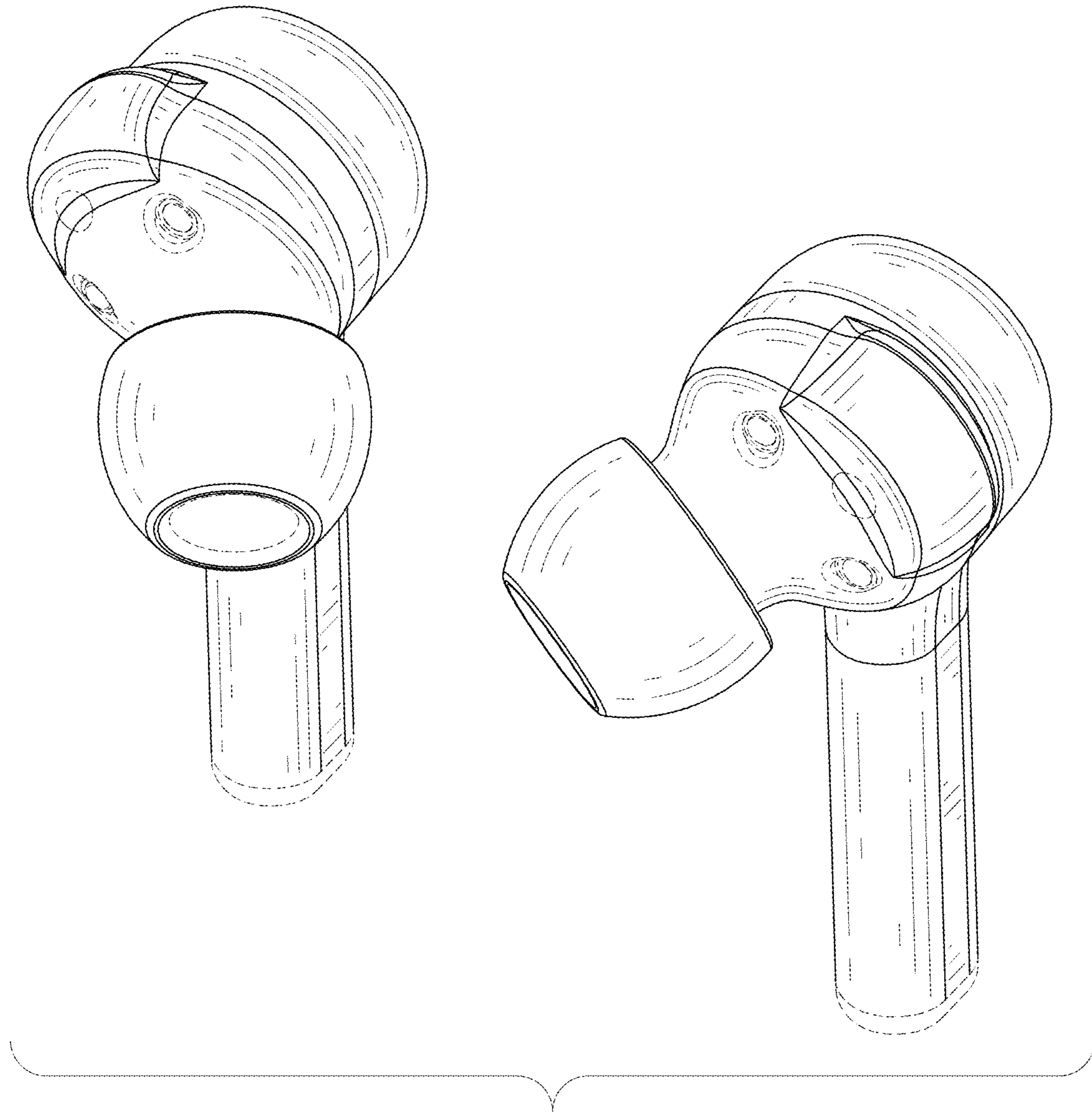


FIG. 1

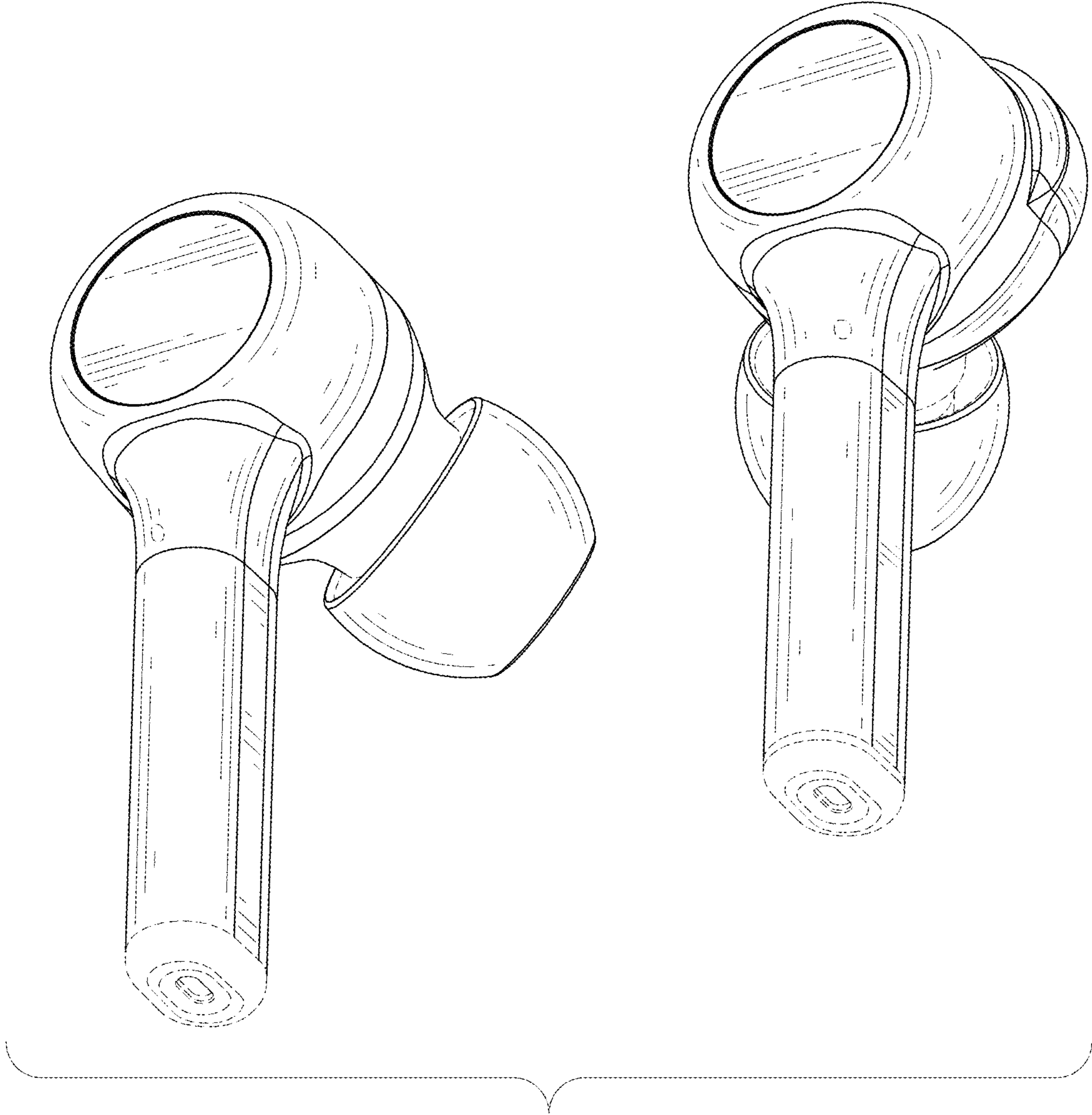


FIG. 2

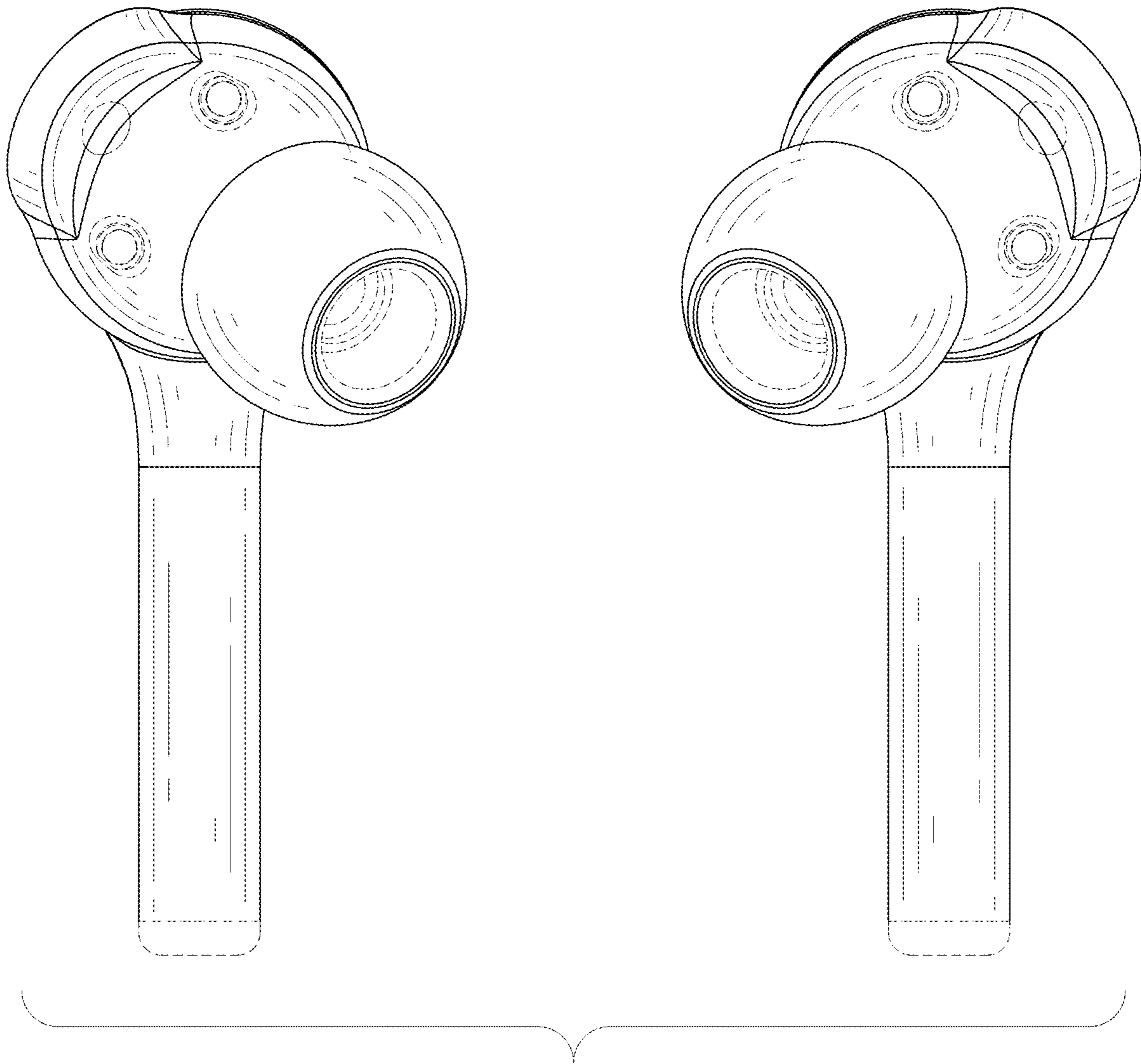


FIG. 3

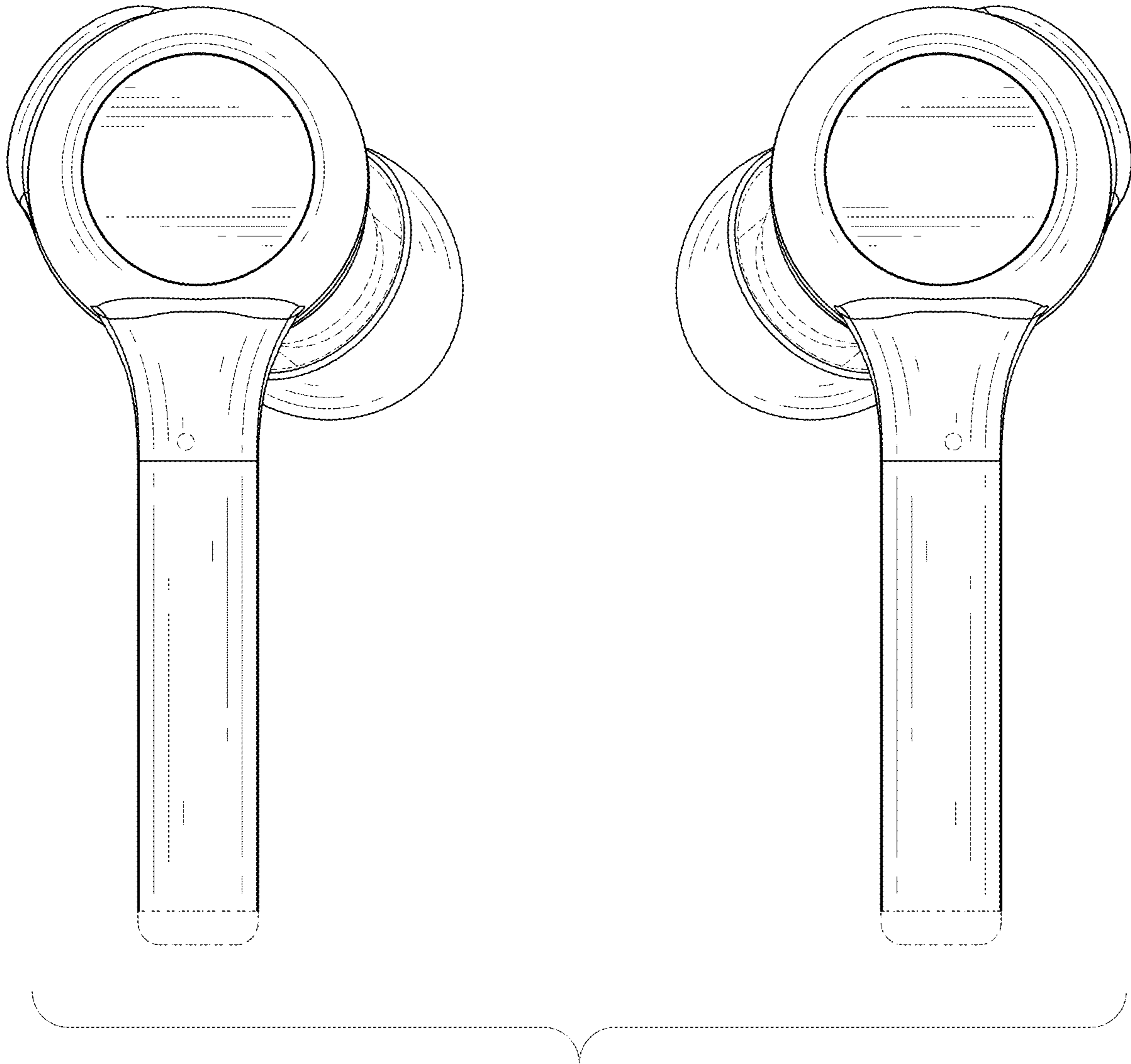


FIG. 4

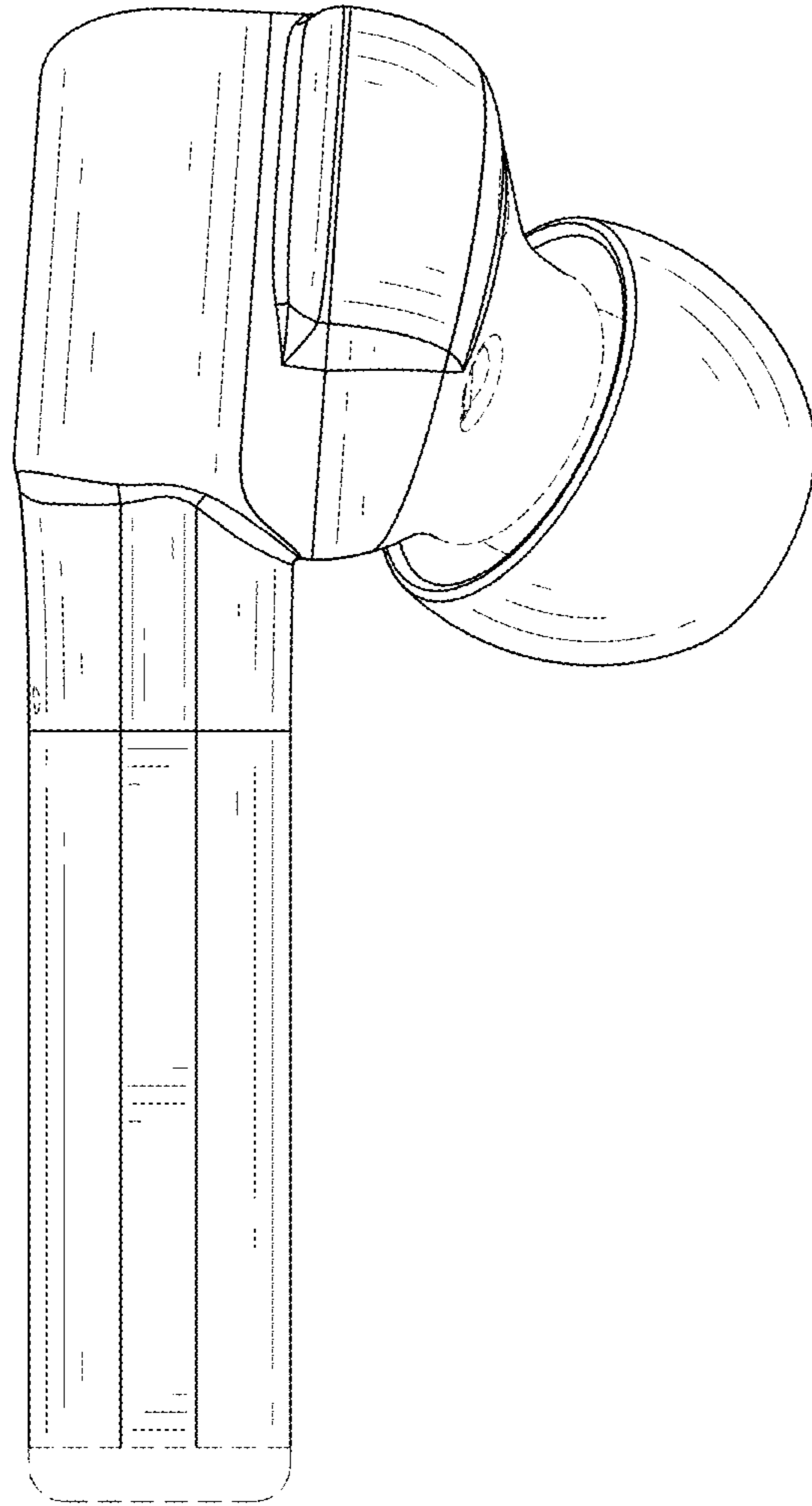


FIG. 5

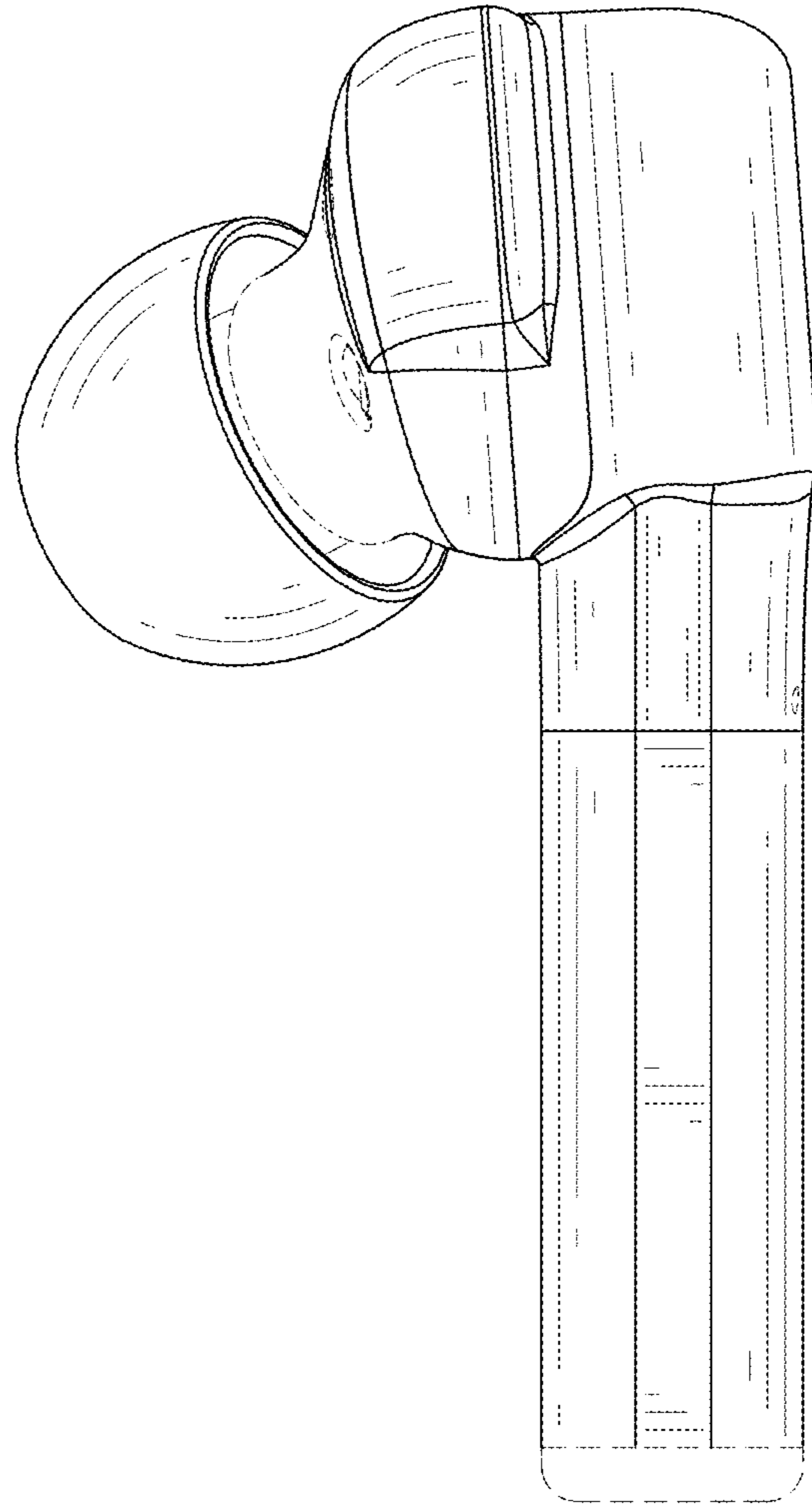


FIG. 6

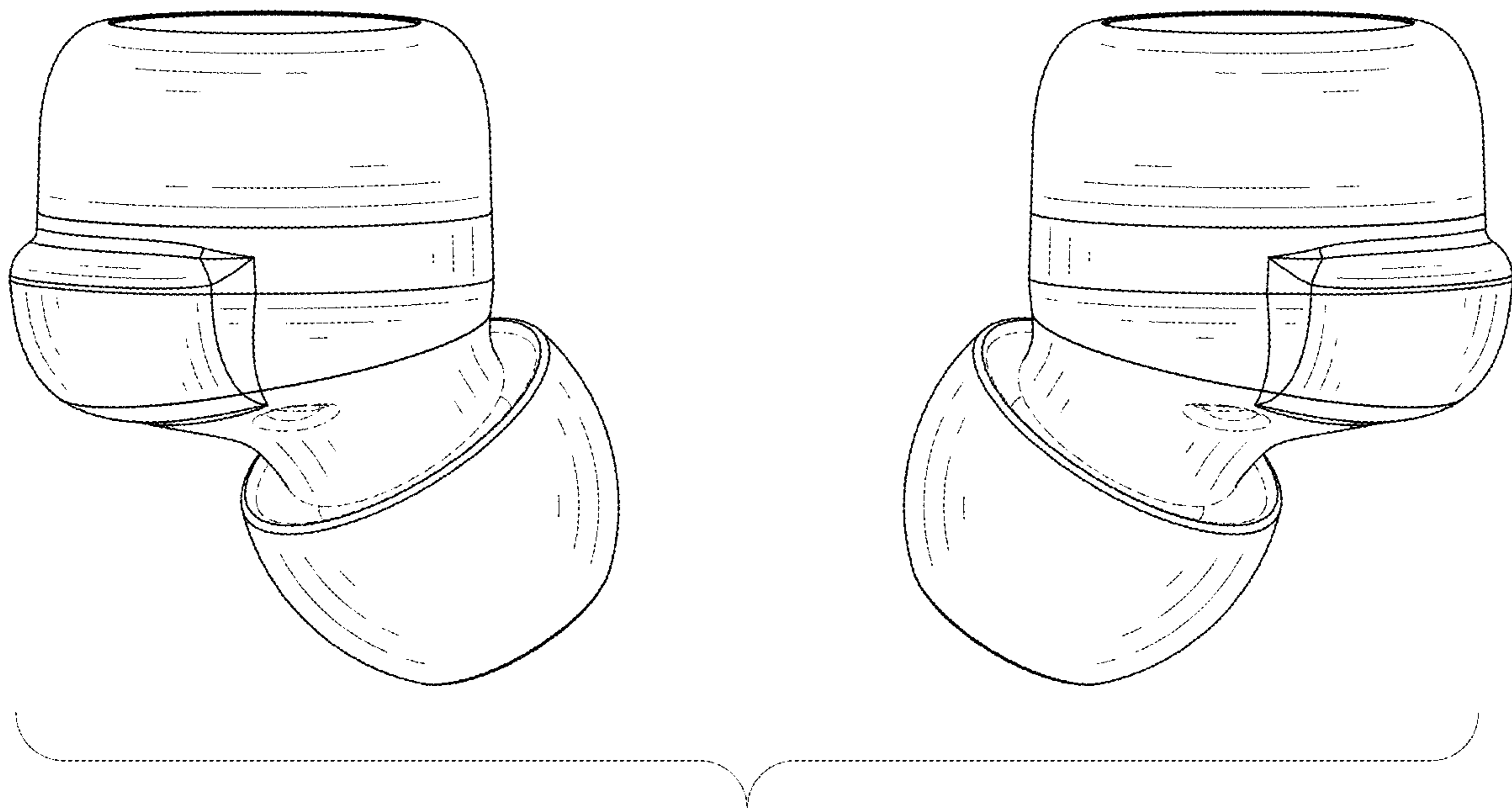


FIG. 7

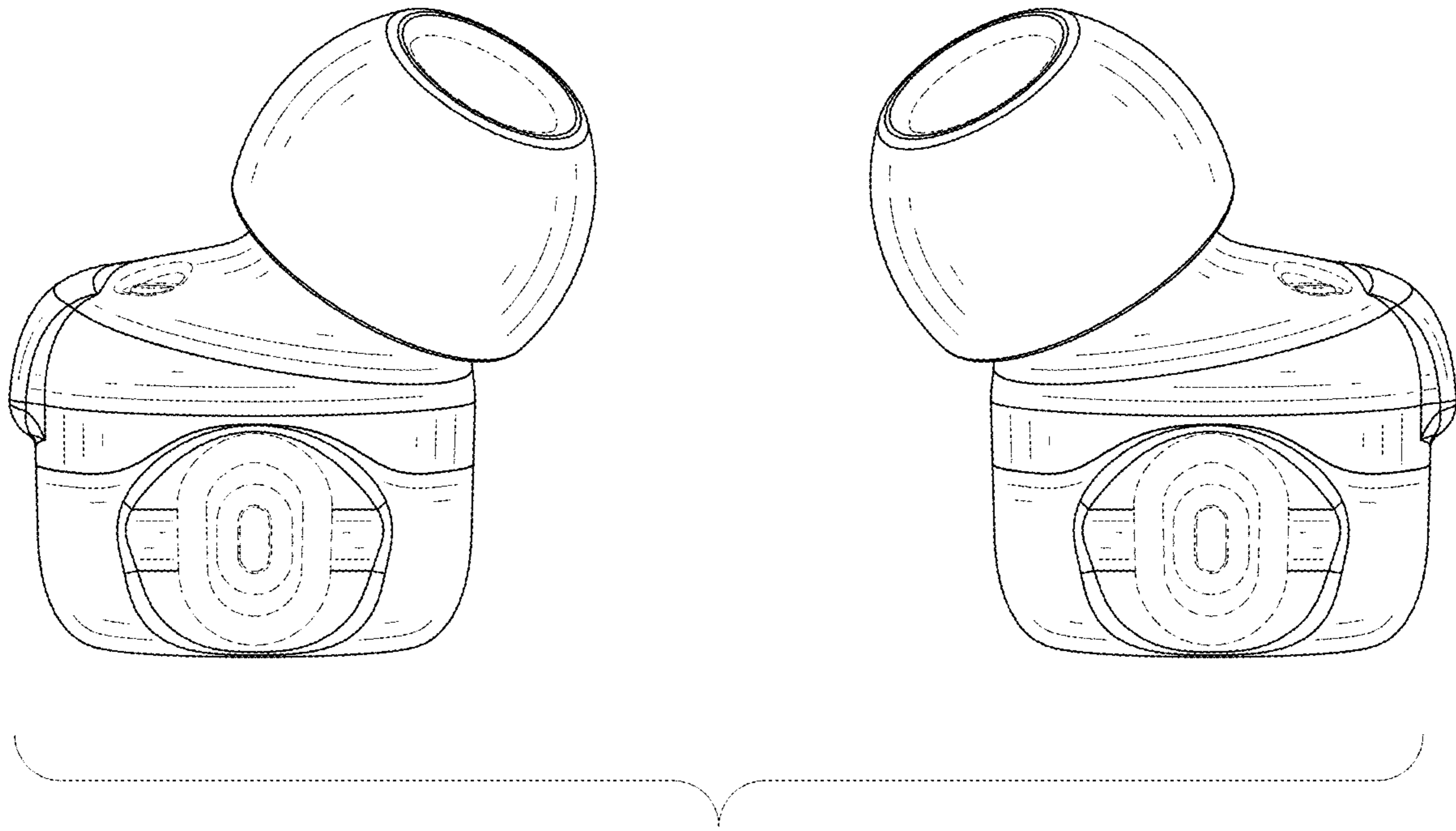


FIG. 8

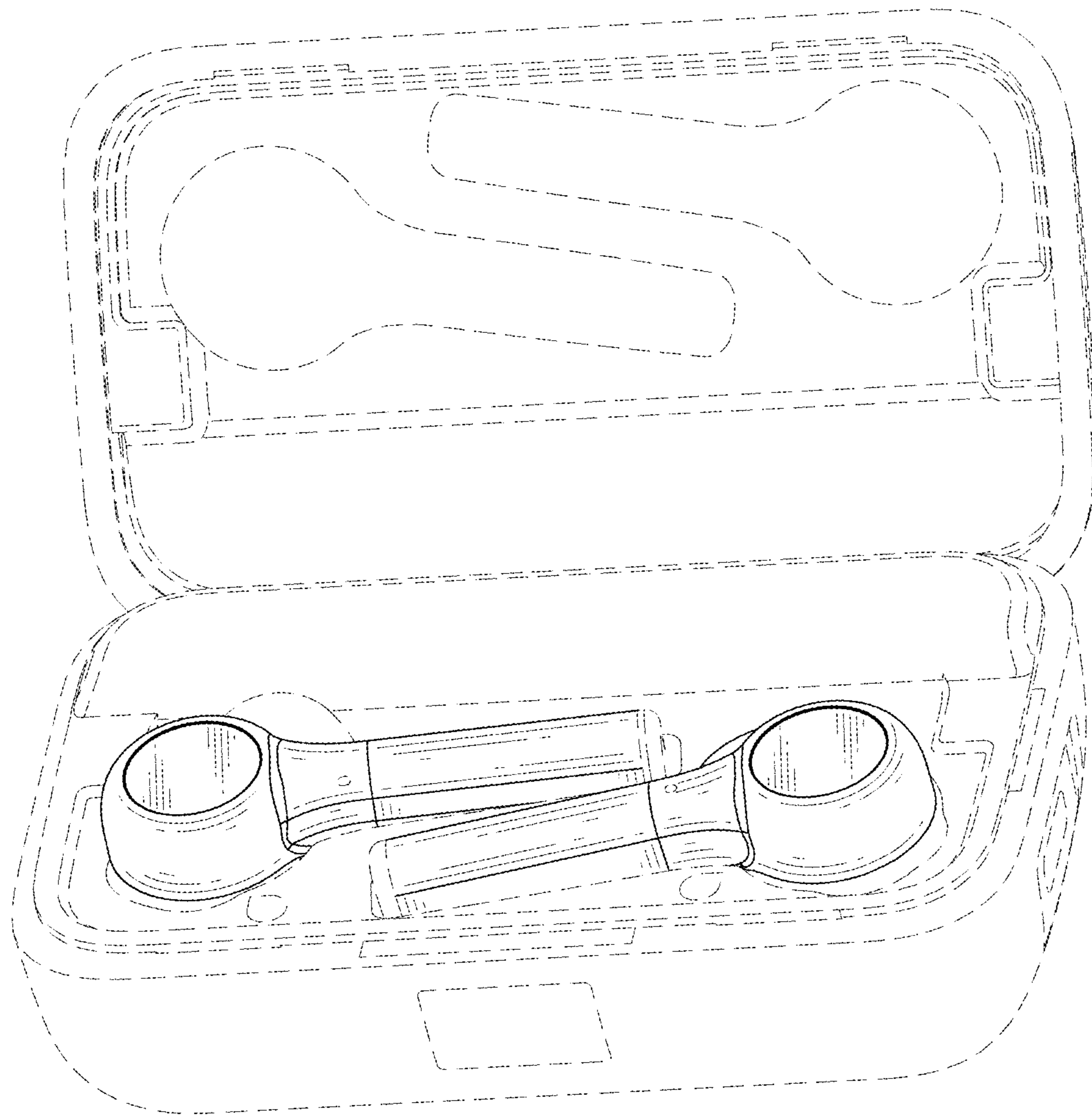


FIG. 9